



### NOTES:

1. ALL DIMENSIONS AND TOLERANCES CONFORM TO ANSI Y14.5M-1994
2. SYMBOL 'M' IS THE BALL MATRIX SIZE.
3. CONFORMS TO JEDEC MS-034-AAN-1

PK038\_01\_110309

## Revision History

The following table shows the revision history for this document.

Date	Version	Description of Revisions
03/12/09	1.3	Removed note 3 regarding component land diameter. This dimension is specified in <a href="#">UG112</a> , Device Package User Guide under Recommended PCB Design Rules.
11/12/09	1.4	Changed symbol ddd value from 0.30 to 0.25 to conform to JEDEC MS-034.

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